

# **Q80SV\_150W Series**

**150W 1/4<sup>th</sup> Brick DC/DC Power Modules** 





Input voltage: 14.4~170V continuous 12V/200V transient Single output: 5V, 12V, 15V, 24V, 54V Output power: 150W

## **FEATURES**

#### Electrical

- Efficiency up to 90% @110Vin
- Meet requirements of EN50155
- Package with Industry Standard Pinout
- Dimension: 2.39"\*1.54"\*0.5"(60.6\*39\*12.7mm)
- Output over-voltage protection, Output over- current protection, Over temperature protection.
- Without tantalum capacitor inside module
- Operating Baseplate Temperature: 40°C ~+105°C
- 4242VDC input to output reinforced isolation
- Applied to altitude up to 5000m

#### Safety & Certificate

- UL60950-1, UL62368-1
- Fire & Smoke meet EN45545
- ISO 9001, TL 9000, ISO 14001, QS 9000, OHSAS18001 certified manufacturing facility

#### **Soldering Method**

- Wave soldering
- Hand soldering

Recommended Part Number							
Model Name	Input	Ou	tput	Eff. @ 100% Load	Others		
Q80SV05030PRFA	24/48/72/110V (14.4~170V)	5V	30A	88.3% @110V			
Q80SV12013PRFA		12V	12.5A	90% @110V			
Q80SV15010PRFA		15V	10A	89.5%@110V	Positive on/off Unthreaded mounting hole		
Q80SV24006PRFA		24V	6.3A	89.3% @110V			
Q80SV54003PRFA		54V	2.8A	89.5% @110V			

Part	Part Numbering System								
Q	80	S	V	XXXXX	Р	R	F	Α	
Form Factor	Input Voltage	Number Of Outputs	Product Series	Output Voltage & Current	ON/OFF Logic	Pin Length	Option Code	Option Code	
Q - 1/4 Brick	80 - 14.4~170V	S - Single	V - Series Number	05030 - 5.0V & 30A 12013 - 12V & 12.5A 15010 - 15V & 10A 24006 - 24V & 6.3A 54003 - 54V & 2.8A	P - Positive N - Negative	R - 0.170"	F - RoHS 6/6 (Lead Free)	A - unthreaded mounting hole S - with threaded mounting hole(M3*0.5)	



## **ELECTRICAL SPECIFICATIONS**

Attribute		Model	Q80SV05030	Q80SV12013	Q80SV15010	Q80SV24006	Q80SV54003		
	Voltage			14.4~170Vdc					
	Voltage	Transient	12V-14.4V/1s, 170V-200V/1s						
		@14.4Vin, full load	13A	12.5A	12.5A	12.5A	12.5A		
INPUT	Current	@110Vin, No load	20mA	20mA	20mA	20mA	20mA		
		@Enable off & 110V			15mA				
	Efficiency	110Vin, 100% load	88.3%	90.0%	89.5%	89.3%	89.5%		
	Linciency	110Vin, 60% load	87.1%	88.5%	88.5%	88.6%	88.1%		
	Voltage Sett 25°C)	ing (72Vin,full load,	5V±1%	12V±1%	15V±1%	24V±1%	54V±1%		
	Current Rati	ng	0~30A	0~12.5A	0~10.0A	0~6.3A	0~2.8A		
	Voltage trim	range Note1	-20~10%	-20~10%	-20~10%	-20~18%	-20%~10%		
	Ripple & No	se Vpp Note2	<1.5%	<1.5%	<3%	<1.5%	<1.5%		
		Line		•	0.2% Max				
	Output	Load			0.2% Max				
OUTPUT	Regulation	Temperature			0.004%/°C				
		Delay from input			250ms				
	Start-up Time Note3	Delay from on/off			250ms				
	Time holes	Rise time	50ms	25ms	50ms	50ms	55ms		
	Transient	Voltage deviation			5%				
	response Note4	Response time			<1ms				
	Output capa	citance	0~ 10000uF	0~ 10000uF	100~ 5000uF	0~ 5000uF	0~ 1000uF		
	Output Over	Current (hiccup)			110%~190% lomax				
	Output Over Voltage (hiccup)		6~10V	14~17V	18~24V	30~36V	60~75V		
	Lawrent	On threshold			12.2~13.8V				
PROTECTION	Input	Off threshold			9.5~12V				
	UVLO	Hysteresis	2.2V						
	OTP	NTC temperature			125 ℃				
	shutdown	Restart Hysteresis	15 ℃						
	Voltage, Inp	ut to Output	4242Vdc						
ISOLATION	Voltage, Inp	ut to baseplate	2250Vdc						
ISOLATION	Voltage, Out	put to baseplate	2250Vdc						
	Resistance (	at 500Vdc)	100 MΩ min						
	Operating an	mbient temperature	-40~85°C						
	Operating ba	aseplate temperature	-40~105℃						
ENVIRONMENT	Storage tem	perature	-40~125℃						
	Operating H	umidity	Max 95%						
	Shock & Vib		EN 61373						
	Logic low		-0.7~0.8V						
Enable control	Logic high		2.5-5V						
	Current (V <sub>on/off</sub> =0V)		1mA max						
	Voltage when floating		<10V						
	Switching Fr	equency			250kHz				
Othors	MTBF (72Vi	n,80% load,25℃)	597K hours						
Others –	Weight		88g						
	Altitude				5000m				

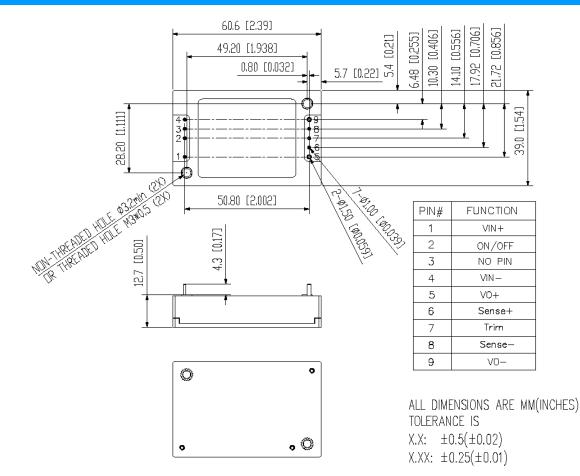
Notes (All specifications valid at 72Vin,100% Rated load and 25°C ambient, unless otherwise indicated.)

- \*1 Maximum output power & current of the module should not over rated output power & current.
- \*2 Ripple & Noise measurement bandwidth is 0-20MHz, Vin=72V, full load, Cout=100uF polymer +4.7uF ceramic.
- \*3 "Delay from input": from Vin reaching turn-on threshold to 10% Vout (pre-applied enable);
- "Delay from on/off": From enable to 10% Vout (pre-applied Vin); "Rise time" From 10% to 90% Vout.
- \*4 Load transient test condition: 72Vin, 50% to 75% full load, 100uF Polymer Capacitor load cap, 0.1A/us.
- \*5 Define that the maximum Vin rising rate is 100V/ms and the recommend output capacitance is 100uF.
- \*6 The recommended external input capacitance is 100uF.

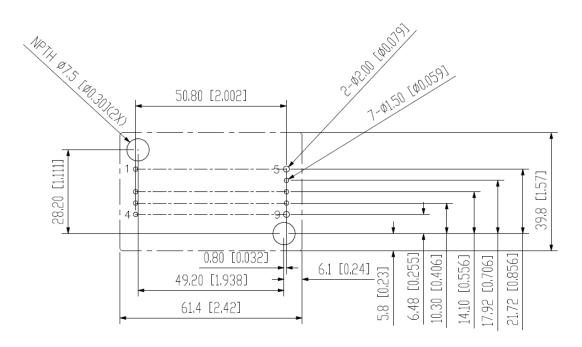


## **MECHANICAL DRAWING**

## **Mechanical Drawing**



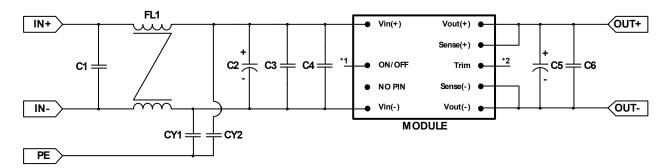
**Recommended Pad Layout** 





## **APPLICATION SCHEMATIC**

### **Typical EMI Filter Circuit for EN55032 Class A Conducted Emission**



- \* Compliance to EN50155
- \* 1, 2: Please refer to page12 for the remote On/Off (pin2) and Trim (pin7) implementation.

Location	Vendor P/N	Description	Qty	Vendor	Purpose
C1	D3D2H505KB00352	500V 5uF K S27.5 32*11*20	2	FARATRONIC	EMC
FL1	PH9455.155NL	19A 1.62mH NPB SRF 10MHz	1	Pulse	EMC
CY1	CS12-F2GA472MYNSAC	250VAC 4700pF M F VI7.5	5	TDK	EMC
CY2	CS12-F2GA472MYNSAC	250VAC 4700pF M F VI7.5	5	TDK	EMC
C2	EKXG251EC3221MMN3S	250V 220uF M 18*31.5	1	NCC	EMC
C3	C1210X684K251TX	250V 0.68uF K X7R 1210	3	HOLY STONE	EMC
C4	GRM32DR72E104KW01L	250V 0.1uF K X7R 1210	1	MURATA	EMC
C5	100PX100MEFCT810X16	100V 100uF M 10*16	1	RUBYCON	RIPPLE
C6	C1210X475K101TX	100V 4.7uF K X7R 1210	1	HOLY STONE	RIPPLE

\* The components for EMC purpose can be deleted if no EMC requirement.



## 1. Q80SV05030 (5V OUTPUT)

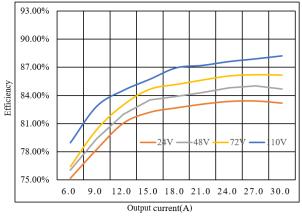
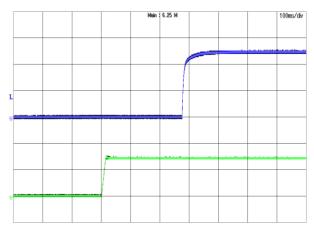
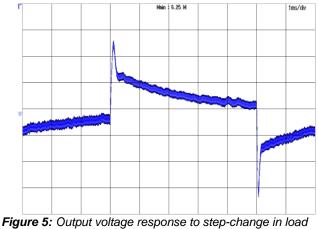


Figure 1: Efficiency vs. load current at 25°C.



*Figure 3:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 2V/div; Bottom Trace: Vin, 50V/div



**Figure 5:** Output voltage response to step-change in load current (50%-75%-50% of full load; di/dt = 0.1A/µs). Trace: Vout, 100mV/div; Time: 1ms/div

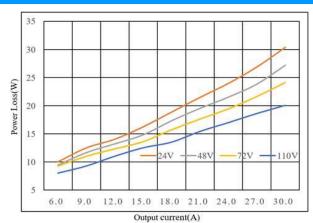
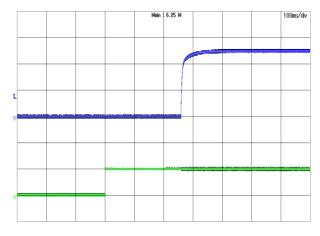
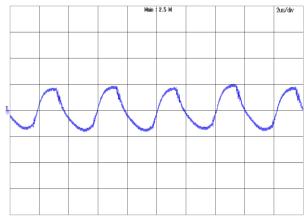


Figure 2: Power loss vs. load current at 25°C.



*Figure 4:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 2V/div; Bottom Trace: ON/OFF, 5V/div



*Figure 6:* Output voltage ripple at Vin=72V and full load Trace: Vout, 20mV/div, 2us/div; Bandwidth: 20 MHz.



## 2. Q80SV12013 (12V OUTPUT)

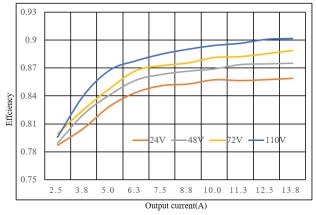
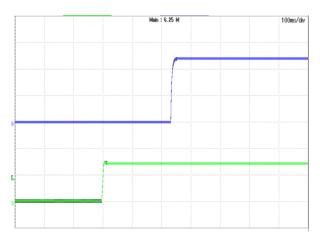
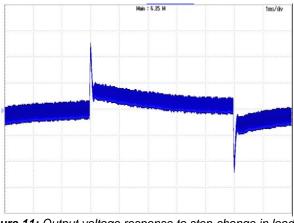


Figure 7: Efficiency vs. load current at 25°C.



*Figure 9:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: Vin, 50V/div



**Figure 11:** Output voltage response to step-change in load current (50%-75%-50% of full load; di/dt = 0.1A/µs). Trace: Vout, 200mV/div; Time: 1ms/div

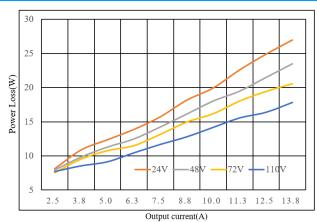
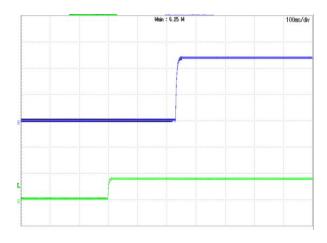
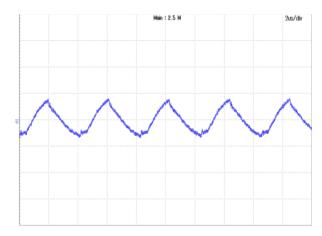


Figure 8: Power loss vs. load current at 25°C.



*Figure 10:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: ON/OFF, 5V/div



**Figure 12:** Output voltage ripple at Vin=72V and full load Trace: Vout, 100mV/div, 2us/div; Bandwidth: 20 MHz.



## 3. Q80SV15010 (15V OUTPUT)

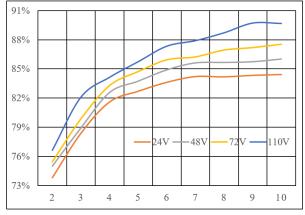
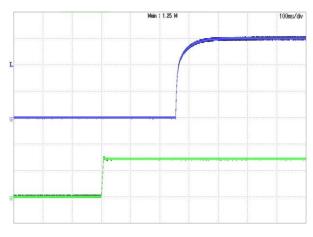
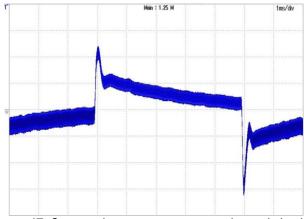


Figure 13: Efficiency vs. load current at 25°C.



*Figure 15:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: Vin, 50V/div



**Figure 17:** Output voltage response to step-change in load current (50%-75%-50% of full load; di/dt =  $0.1A/\mu$ s). Trace: Vout, 200mV/div; Time: 1ms/div

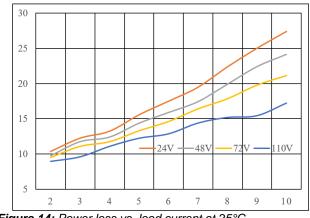
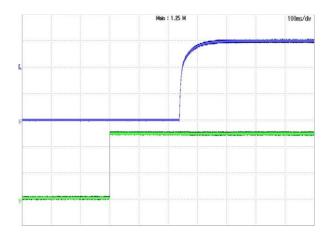
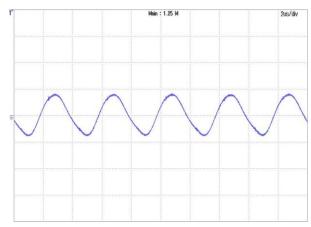


Figure 14: Power loss vs. load current at 25°C.



**Figure 16:** Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: ON/OFF, 5V/div



*Figure 18:* Output voltage ripple at Vin=72V and full load Trace: Vout, 100 mV/div, 2us/div; Bandwidth: 20 MHz.



## 4. Q80SV24006 (24V OUTPUT)

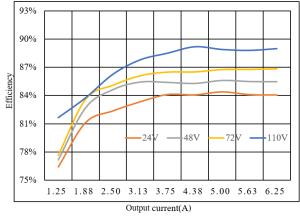
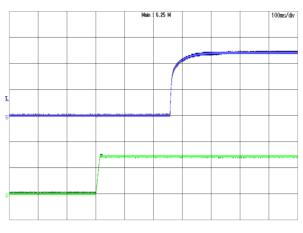
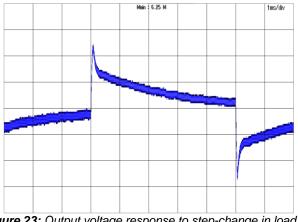


Figure 19: Efficiency vs. load current at 25°C.



*Figure 21:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: Vin, 50V/div



**Figure 23:** Output voltage response to step-change in load current (50%-75%-50% of full load; di/dt =  $0.1A/\mu$ s). Trace: Vout, 300mV/div; Time: 1ms/div

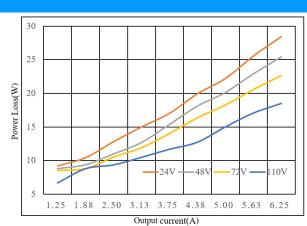
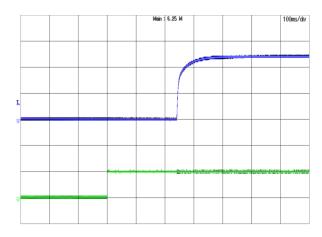
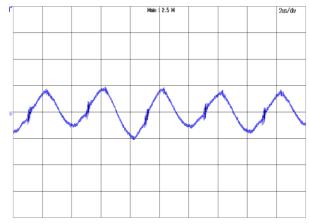


Figure 20: Power loss vs. load current at 25°C.



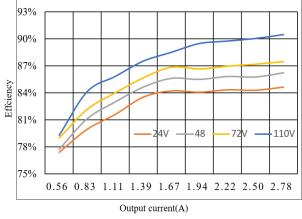
*Figure 22:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 5V/div; Bottom Trace: ON/OFF, 5V/div

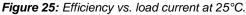


*Figure 24:* Output voltage ripple at Vin=72V and full load Trace: Vout, 100 mV/div, 2us/div; Bandwidth: 20 MHz.



### 5. Q80SV54003 (54V OUTPUT)





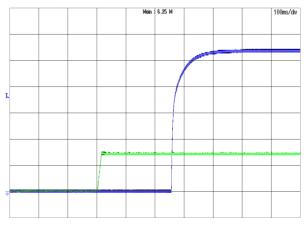
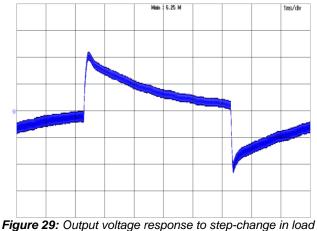


Figure 27: Turn-on transient at full load current (100ms/div).

Top Trac	e: Vout, '	10V/div;	Bottom	Trace:	Vin,	50V/div
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*Figure 29:* Output voltage response to step-change in load current (50%-75%-50% of full load;  $di/dt = 0.1A/\mu s$ ). Trace: Vout, 500mV/div; Time: 1ms/div

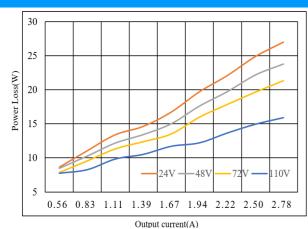
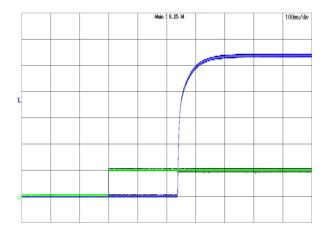
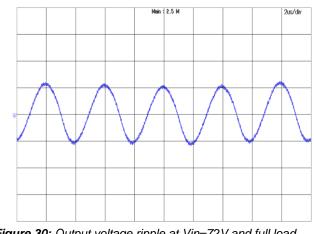


Figure 26: Power loss vs. load current at 25°C.



*Figure 28:* Turn-on transient at full load current (100ms/div). Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF, 5V/div



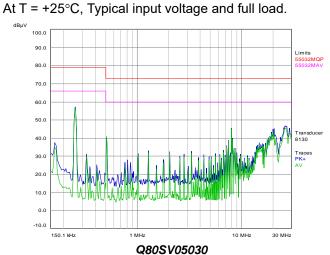
*Figure 30:* Output voltage ripple at Vin=72V and full load Trace: Vout, 100 mV/div, 2us/div; Bandwidth: 20 MHz.

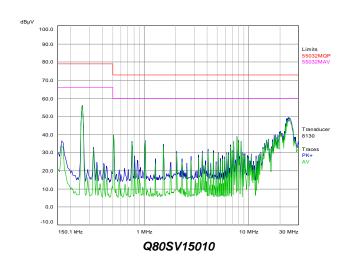


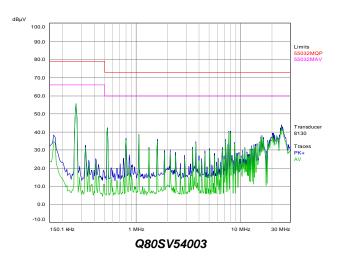
### Layout and EMI Considerations

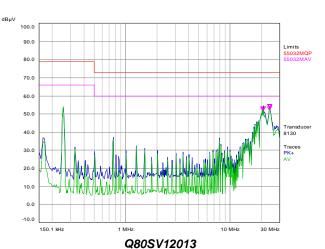
Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team.

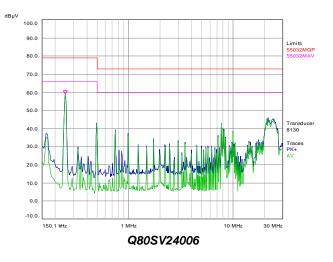
Below is the EN55032 Class A Conducted Emission test result using typical EMI filter circuit.













#### **Protection Features**

#### **Over-Current Protection:**

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the module will shut down, and always try to restart (hiccup mode) until the over current condition is corrected.

#### **Over-Voltage Protection:**

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the overvoltage set point, the module will shut down, and always try to restart until the over current condition is corrected

#### **Over-Temperature Protection:**

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the over-temperature is detected the module will shut down, and restart after the temperature is within specification.

#### Remote On/off(Pin2):

The remote On/Off feature on the module can be either negative or positive logic depend on the part number options on the first page.

For Negative logic version: turns the module on during an external logic low and off during a logic high. If the remote on/off feature is not used, please short the On/Off pin to Vin(-).

For Positive logic version: turns the modules on during an external logic high and off during a logic low. If the remote On/Off feature is not used, please leave the On/Off pin to floating.

Remote On/Off can be controlled by an external switch between the On/Off terminal and the Vin(-) terminal. The switch can be an open collector or open drain, as showed in below picture (figure 31)

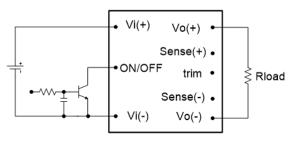


Figure 31: Remote On/Off Implementation

#### Trim (PIN7):

To increase or decrease the output voltage set point, connect an external resistor between the TRIM pin and SENSE (+) pin or SENSE (-) pin. The TRIM pin should be left open if this feature is not used.

Take Q80SV12013 as example, for trim down, the external resistor value required to obtain a percentage of output voltage change  $\Delta$  is defined as:

$$R_{trim - down} = \left[\frac{5.11}{\Delta} - 10.22\right] (K\Omega)$$

Ex. When Trim-down -10% (12V×0.9=10.8V)

$$R_{trim-down} = \left\lfloor \frac{5.11}{10\%} - 10.22 \right\rfloor (K\Omega) = 40.88 (K\Omega)$$

For trim up, the external resistor value required to obtain a percentage output voltage change  $\Delta$  is defined as:

$$R_{trim-up} = \left[\frac{45}{\Delta} + 40\right] K\Omega$$

Ex. When Trim-up +10% (12V×110%=13.2V)

$$R_{trim - up} = \left[\frac{45}{10\%} + 40\right] = 490(K\Omega)$$

	Rtrim-up /kohm	Rtrim-down /kohm
Q80SV05030	$\frac{15.8}{\Delta} + 10.6$	$\frac{5.11}{\Delta}$ - 10.22
Q80SV12013	$\frac{45}{\Delta}$ + 40	$\frac{5.11}{\Delta}$ -10.22
Q80SV15010	$\frac{57.46}{\Delta} + 52.35$	$\frac{5.11}{\Delta}$ -10.22
Q80SV24006	$\frac{95}{\Delta}$ + 90	$\frac{5.11}{\Delta}$ -10.22
Q80SV54003	$\frac{220}{\Delta}$ + 215	$\frac{5.11}{\Delta}$ -10.22

#### **Safety Considerations**

The power module must be installed in compliance with the spacing and separation requirements of the enduser's safety agency standard, i.e., EN 60950-1: 2006 + A11: 2009 + A1: 2010 + A12: 2011 + A2: 2013, IEC 60950-1: 2005, 2<sup>nd</sup> Edition + A1: 2009 + A2: 2013, CSA C22.2 No. 60950-1-07, 2<sup>nd</sup> Edition, 2014-10 and UL 60950-1, 2<sup>nd</sup> Edition, 2014-10-14, EN 62368-1: 2014, IEC 62368-1: 2014, CSA C22.2 No. 62368-1-14, 2<sup>nd</sup> Edition and UL 62368-1, 2<sup>nd</sup> Edition, if the system in which the power module is to be used must meet safety agency requirements.

Reinforced insulation is provided between the input and output of the module. Input is considered as secondary hazardous voltage which main transient is up to 1500Vpk and output is considered as SELV circuit. The input source must be insulated from the ac mains by reinforced or double insulation. The input terminals of the module are not considered as operator accessible.

A SELV reliability test may require when install on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.



When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a fast-blow fuse with 25A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

### Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

### **Thermal Considerations**

The thermal curve is based on the test setup shown as figure 32. The module is mounted on an Al plate and was cooled by cooling liquid.

Figure 33 shows the location to monitor the temperature of the module's baseplate. The baseplate temperature in thermal curve is a reference for customer to make thermal evaluation and make sure the module is operated under allowable temperature.

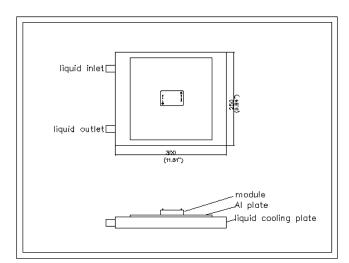


Figure 32: Thermal Test setup

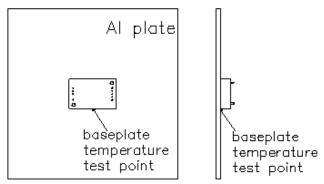


Figure 33: Temperature measured point



### Thermal Curves (Base Plate Is Attached To Cold Plate)

#### Thermal Curves (Q80SV05030)

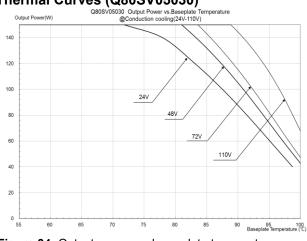


Figure 34: Output power vs. base plate temperature  $@V_{in}=24$ ~110V  $V_{out}=5V$ 

#### Thermal Curves (Q80SV24006)

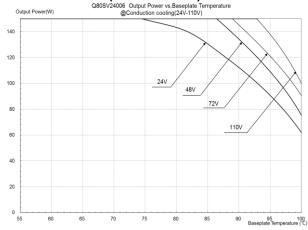


Figure 36: Output power vs. base plate temperature  $@V_{in}=24$ ~110V  $V_{out}=24V$ 

#### Thermal Curves (Q80SV12013 & Q80SV15010)

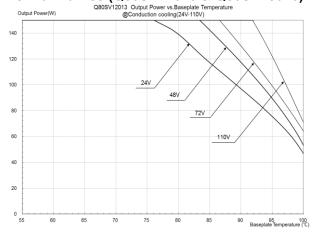


Figure 35: Output power vs. base plate temperature  $@V_{in}=24$ ~110V  $V_{out}=12V$  or 15V

#### Thermal Curves (Q80SV54003)

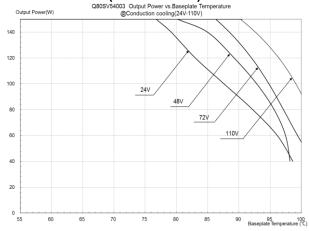


Figure 37: Output power vs. base plate temperature  $@V_{in}=24 \sim 110V V_{out}=54V$ 



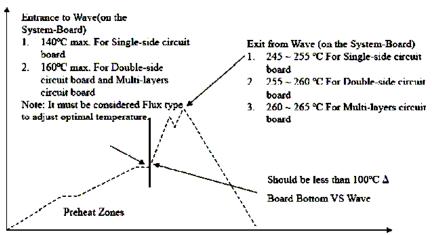
## Soldering Method

Generally, as the most common mass soldering method for the solder attachment, wave soldering is used for through-hole power modules and reflow soldering is used for surface-mount ones. Delta recommended soldering methods and process parameters are provided in this document for solder attachment of power modules onto system board. SAC305 is the suggested lead-free solder alloy for all soldering methods. The soldering temperature profile presented in this document is based on SAC305 solder alloy.

Reflow soldering is not a suggested method for through-hole power modules due to many process and reliability concerns, and reflow is prohibited for potting model.

## Wave Soldering (Lead-free)

Delta's power modules are designed to be compatible with single-wave or dual wave soldering. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously. The recommended wave-soldering profile is shown below:



Note: The temperature is measured on solder joint of pins of power module.

The typical recommended (for double-side circuit board) preheat temperature is  $115+/-10^{\circ}$ C on the top side (component side) of the circuit board. The circuit-board bottom-side preheat temperature is typically recommended to be greater than  $135^{\circ}$ C and preferably within  $100^{\circ}$ C of the solder-wave temperature. A maximum recommended preheat up rate is  $3^{\circ}$ C/s. A maximum recommended solder pot temperature is  $255+/-5^{\circ}$ C with solder-wave dwell time of  $3\sim6$  seconds. The cooling down rate is typically recommended to be  $6^{\circ}$ C/s maximum.

### Hand Soldering (Lead Free)

Hand soldering is the least preferred method because the amount of solder applied, the time the soldering iron is held on the joint, the temperature of the iron, and the temperature of the solder joint are variable. The recommended hand soldering guideline is listed in Table below. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°Ccontinuously.

Parameter	Single-side	Double-side	Multi-layers
	Circuit Board	Circuit Board	Circuit Board
Soldering Iron Wattage	90	90	90
Tip Temperature	385+/-10°C	420+/-10°C	420+/-10°C
Soldering Time	$2 \sim 6$ seconds	$4 \sim 10$ seconds	$4\sim 10 \ seconds$



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